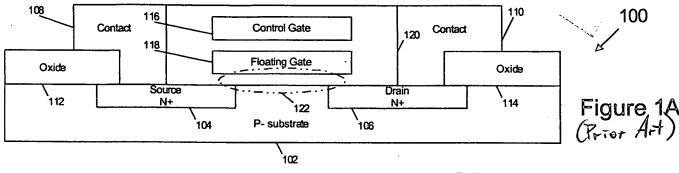
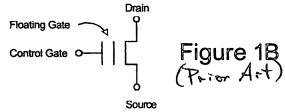
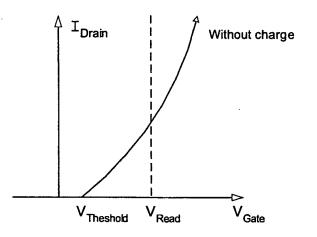


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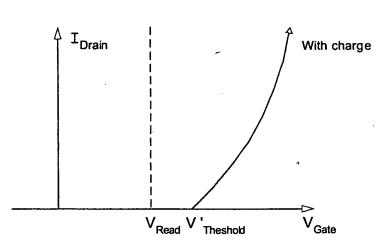
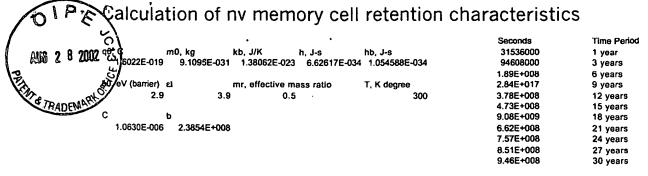


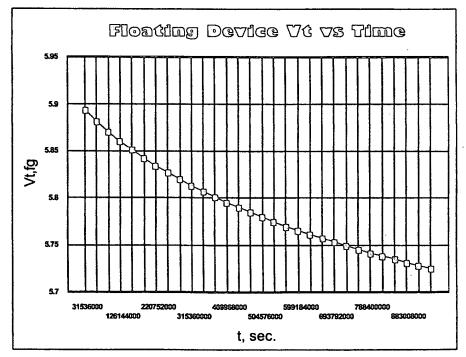
Figure 1C (Prior Art)

Figure 1D (Prior Art)



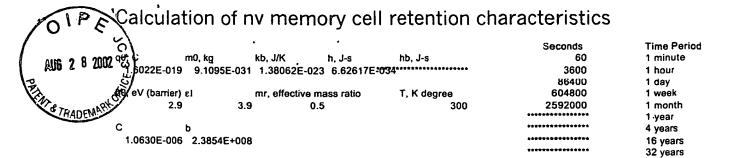
Lfg um	0.6000	Channel length of floating gate device
Wfg um	1000.0000	Channel width of floating gate device.
Hfg um	0.0900	Thickness of floating gate polysilicon conductor
Wrx um	0.5000	Width of floating gate overlapping shallow trench isolation
Ttunox A	80	Tunnel oxide thickness
Tono A	190	Thickness of Oxide-Nitride-Oxide dielectric between floating gate and control gate for capacitive coupling
Tswox A	300	Thickness of sidewall oxide between floating gate and control gate for sidewall coupling
Xfd um	0.0500	Length of floating gate overlapping drain region of the floating gate MOSFET
Xfs um	0.3500	Length of floating gate overlapping source region of the floating gate MOSFET
Ainj um2	0.0438	Area of the electron tunneling region between the floating gate and the source for resetting the floating gate charge
Cfc fF	1089.5358	Capacitance between the floating gate and the control gate
Cfsx fF	0.4313	Capacitance between the floating gate and the silicon substrate
Cfd fF	0.1078	Capacitance between the floating gate and the drain
Cfs fF	0.7547	Capacitance between the floating gate and the source
Cfg fF	1090.8295	Total floating gate capacitance
Cr,wl	0.9988	Control gate to floating gate coupling ratio
Cr,src	0.0007	Source junction to floating gate coupling ratio
Vt,fg V	0.90	Threshold voltage of floating gate MOSFET
Verase	0.00	Erase voltage applied to the source(not used here, set to zero)
Vfg,ini	-5.00	Initial floating chaged voltage
Va	0.00	Actual erase volatge (equal to applied + charge stored on the floating)
S	3.76E+016	Derived parameter in the floating gate "erase" equation
х	1.27E+011	Derived parameter in the floating gate "erase" equation

t, sec. \	/t,fg
0.00001	5.907
31536000	5.894
63072000	5.882
94608000	5.871
1.26E+008	5.861
1.58E+008	5.852
1.89E+008	5.843
2.21E+008	5.835
2.52E+008	5.827
2.84E+008	5.820
3.15E+008	5.814
3.47E+008	5.807
3.78E+008	5.801
4.1E+008	5.795
4.42E+008	5.790
4.73E+008	5.785
5.05E+008	5.780
5.36E+008	5.775
5.68E+008	5.770
5.99E+008	5.766
6.31E+008	5.762
6.62E+008	5.757
6.94E+008	5.753
7.25E+008	5.750
7.57E+008	5.746
7.88E+008	5.742
8.2E+008	5.739
8.51E+008	5.735
8.83E+008	5.732
9.15E+008	5.729
9.46E+008	5.726



Figures 1E-1F (Peror AH)

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Lfg um	0.6000 Channel length of floating gate device	
Wfg um	1000.0000 Channel width of floating gate device.	
Hfg um	0.0900 Thickness of floating gate polysilicon conductor	
Wrx um	0.5000 Width of floating gate overlapping shallow trench isolation	
Ttunox A	80 Tunnel oxide thickness	
Tono A	190 Thickness of Oxide-Nitride-Oxide dielectric between floating gate and control gate for capa	citive coupling
Tswox A	300 Thickness of sidewall oxide between floating gate and control gate for sidewall coupling	g
Xfd um	0.0500 Length of floating gate overlapping drain region of the floating gate MOSFET	 i
Xfs um	0.3500 Length of floating gate overlapping source region of the floating gate MOSFET	<u>m</u>
Ainj um2	0.0438 Area of the electron tunneling region between the floating gate and the source for resetting	the floating date charge
Cfc fF	1089.5358 Capacitance between the floating gate and the control gate	· 2
Cfsx fF	0.4313 Capacitance between the floating gate and the silicon substrate	지 않 의
Cfd fF	0.1078 Capacitance between the floating gate and the drain	5 F O
Cfs fF	0.7547 Capacitance between the floating gate and the source	P- CE
Cfg fF	1090.8295 Total floating gate capacitance	
Cr,wi	0.9988 Control gate to floating gate coupling ratio	
Cr.src		
Cijaic	0.0007 Source junction to floating gate coupling ratio	2002 2002
Vt.fg V	O O Throughold valters of floating anto MOSET	VED GENTER
Verase	0.90 Threshold voltage of floating gate MOSFET	N
Verase Vfg,ini	0.00 Erase voltage applied to the source(not used here, set to zero)	8
•	-5.00 Initial floating chaged voltage	800
Va '	0.00 Actual erase volatge (equal to applied + charge stored on the floating)	1
S	3.76E+016 Derived parameter in the floating gate "erase" equation	
X	1.27E+011 Derived parameter in the floating gate "erase" equation	

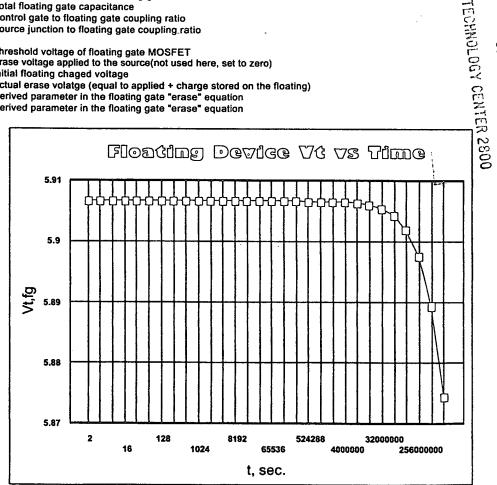
t, sec. Vt,tg 0.00001 5.907 Floating Device Vt vs Time 5.907 2 4 5.907 8 5.907 5.95 16 5.907 32 5.907 64 5.907 128 5.907 5.9 256 5.907 512 5.907 1024 5.907 2048 5.907 4096 5.907 5.85 8192 5.907 16384 5.907 32768 5.907 65536 5.907 5.8 131072 5.907 262144 5.907 524288 5.907 1000000 5.907 5.75 2000000 5.906 4000000 5.905 8000000 5.904 16000000 5.900 32000000 5.894 5.7 64000000 5.881 2 128 32000000 8192 ******** 5.860 16 65536 4000000 256000000 1024 ********** 5.827 5.779 t, sec. ******** 5.718

> Figures 1G-1H (Prior And)

3/22 AUS9-1999-0268-US1 ## decided by the control of the con

Ltg um 0.6000 Channel length of floating gate device Wfg um 1000.0000 Channel width of floating gate device. Hfg um 0.0900 Thickness of floating gate polysilicon conductor Wrx um 0.5000 Width of floating gate overlapping shallow trench isolation Ttunox A 85 Tunnel oxide thickness Tono A 190 Thickness of Oxide-Nitride-Oxide dielectric between floating gate and control gate for capacitive coupling Tswox A 300 Thickness of sidewall oxide between floating gate and control gate for sidewall coupling Xfd um 0.0500 Length of floating gate overlapping drain region of the floating gate MOSFET Xfs um 0.3500 Length of floating gate overlapping source region of the floating gate MOSFET Aini um2 0.0438 Area of the electron tunneling region between the floating gate and the source for resetting the floating gate c Cfc fF 1089.5358 Capacitance between the floating gate and the control gate 0.4059 Capacitance between the floating gate and the silicon substrate Cfsx fF Cfd fF 0.1015 Capacitance between the floating gate and the drain Cfs fF 0.7103 Capacitance between the floating gate and the source Cfg fF 1090.7534 Total floating gate capacitance 0.9989 Control gate to floating gate coupling ratio Cr,wi Cr,src 0.0007 Source junction to floating gate coupling ratio Vt,fg V 0.90 Threshold voltage of floating gate MOSFET Verase 0.00 Erase voltage applied to the source(not used here, set to zero) Vfg,ini -5.00 Initial floating chaged voltage ۷a 0.00 Actual erase volatge (equal to applied + charge stored on the floating) s 4.09E+017 Derived parameter in the floating gate "erase" equation X 1.20E+011 Derived parameter in the floating gate "erase" equation

t, sec. Vt,fg 0.00001 5.907 5.907 5.907 8 5.907 16 5.907 32 5.907 64 5.907 128 5.907 256 5.907 512 5.907 1024 5.907 2048 5.907 4096 5.907 8192 5.907 16384 5.907 32768 5.907 65536 5.907 131072 5.907 262144 5.907 524288 5.907 1000000 5.907 2000000 5.907 4000000 5.906 8000000 5.906 1.6E+007 5.906 3.2E+007 5.905 6.4E+007 5.904 5.902 ********** 5.898 ******** 5.889 ********** 5.874



Figures 11-1J (Prior Art)

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******* 32 years

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